

IEEE 802.3 - Attendance and Affiliation Sheet

Beijing, PRC - March 2014

Name	Employer	Affiliation	Mon	Tue	Wed	Thu	Credit
Abbas, Ghani	Ericsson AB	Ericsson AB	1	1	1	1	4
Abramson, David	Texas Instruments Incorporated	Texas Instruments Incorporated	1	1	1	1	4
Agata, Naoki	KDDI R&D Laboratories	KDDI R&D Laboratories	1	1	1	1	4
Ahmad, Faisal	Akros Silicon Inc.	Akros Silicon Inc.	1	1	1	1	4
Akasaki, Shogo		DENSO		1	1	1	3
Anslow, Peter	Ciena Corporation	Ciena Corporation	1	1	1	1	4
Balasubramanian, Koussalya	Cisco Systems, Inc.	Cisco Systems, Inc.	1	1	1		3
Baldwin, Thananya	Ixia	Ixia	1	1	1	1	4
Barrass, Hugh	Cisco Systems, Inc.	Cisco Systems, Inc.	1	1	1	1	4
Bennett, Michael	Lawrence Berkeley National Lab (LBNL)	Lawrence Berkeley National Lab (LBNL)	1	1		1	3
Booth, Brad	Microsoft Corporation	Microsoft Corporation	1	1	1	1	4
Brillhart, Theodore	Fluke Corporation	Fluke Corporation	1	1	1	1	4
Brown, David	Semtech Ltd	Semtech Ltd	1	1	1	1	4
Brown, Matthew	Applied Micro (AMCC)	Applied Micro (AMCC)	1	1	1		3
Bugg, Mark	Molex Incorporated	Molex Incorporated	1	1	1		3
Buntz, Stefan	Daimler AG	Daimler AG	1	1	1	1	4
Chadha, Mandeep	Vitesse Semiconductor Corporation	Vitesse Semiconductor Corporation		1	1	1	3
Chalupsky, David	Intel Corporation	Intel Corporation	1		1	1	3
Chen, Javen	Microsemi Corporation	Microsemi		1	1	1	3
Choudhury, Golam	CommScope, Inc.	CommScope, Inc.	1	1	1	1	4
Cole, Christopher R	Finisar Corporation	Finisar Corporation	1	1	1	1	4
Conroy, Keith		multiply		1	1	1	3
Cui, Kai	Huawei Technologies Co. Ltd	Huawei Technologies Co. Ltd	1	1	1	1	4
Dai, Eugene	Cox Communications Inc.	Cox Communications Inc.	1	1	1	1	4
Dai, Shaoan	Marvell Semiconductor, Inc.	Marvell Semiconductor, Inc.		1	1	1	3
Dambrosia, John	Dell	Dell	1	1	1	1	4
Darshan, Yair	Microsemi Corporation	Microsemi Corporation	1	1	1	1	4
Dawe, Piers J G	Mellanox Technologies	Mellanox Technologies	1	1	1	1	4
Dawson, Fred	E.I. du Pont Canada Company	DuPont	1	1	1	1	4
Diminico, Christopher	M C Communications, LLC	Panduit	1	1	1	1	4

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Donahue, Curtis	University of New Hampshire InterOpera	UNH-IOL	1	1	1	1	4
Dove, Daniel	Dove Networking Solutions	Applied Micro (AMCC)	1	1	1	1	4
Dwellely, David	Linear Technology	Linear Technology	1	1	1	1	4
Elbakoury, Hesham	Huawei Technologies Co. Ltd	Huawei Technologies Co. Ltd	1	1	1	1	4
Estes, David	University of New Hampshire InterOpera	UNH-IOL	1	1	1	1	4
Flatman, Alan	LAN Technologies Corporation, Inc.	LAN Technologies Corporation, Inc.	1		1	1	3
Frazier, Howard	Broadcom Corporation	Broadcom Corporation	1	1	1	1	4
Frosch, Richard	Phihong USA Inc,	Phihong USA Inc,		1	1	1	3
fu, shiyong		Huawei Technologies Co. Ltd			1	1	2
fu, zhiming		ZTE Corporation	1	1	1	1	4
Fujimoto, Yukihiro	Nippon Telegraph and Telephone Corpo	Nippon Telegraph and Telephone Corpo	1	1			2
furlong, michael		ClariPhy Communications, Inc.	1	1	1	1	4
Goergen, Joel	Cisco Systems, Inc.	Cisco Systems, Inc.	1	1	1	1	4
Gong, Zhigang	JDS Uniphase Corporation	O-Net Communications Ltd.	1	1	1	1	4
Gustlin, Mark	Xilinx	Xilinx	1	1	1	1	4
Hammond, Bernard	TE Connectivity	TE Connectivity	1	1	1	1	4
Healey, Adam	LSI Corporation	LSI Corporation	1	1	1	1	4
Heath, Jeffrey	Linear Technology	Linear Technology	1	1	1	1	4
Herman, Carl	CommScope, Inc.	CommScope, Inc.	1	1	1	1	4
hirayama, hiroki		1394 Trade Association	1	1		1	3
Hirth, Ryan	Broadcom Corporation	Broadcom Corporation		1	1	1	3
Hogenmueller, Thomas	Robert Bosch GmbH	Robert Bosch GmbH	1	1	1		3
Horner, Rita	Synopsys, Inc.	Synopsys, Inc.	1	1	1		3
Hua, Rui	Huawei Technologies Co. Ltd	Huawei Technologies Co. Ltd		1	1	1	3
Huang, Liang-wei	Realtek Semiconductor Corp.	Realtek Semiconductor Corp.	1	1	1		3
Huber, Martin	MD Elektronik GmbH	MD Elektronik GmbH	1	1	1		3
ISHIBE, KAZUHIKO	Anritsu Company	Anritsu Company	1	1	1	1	4
Isono, Hideki	FUJITSU	Fujitsu Optical Components Limited	1	1	1	1	4
Issenhuth, Tom	Microsoft Corporation	Microsoft Corporation	1	1	1	1	4
Itoh, Hideo		National Institute of Advanced Industrial	1				1

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Name	Employer	Affiliation	Mon	Tue	Wed	Thu	Credit
Iwaoka, Mitsuru	Yokogawa Electric Corporation	Yokogawa Electric Corporation				1	1
Jiang, Wenbin	WJ Communications, Inc.	Cosemi Technologies	1	1	1		3
Jiang, Yi		Accelink Technologies Co. Ltd	1	1	1	1	4
Jimenez, Andrew	Anixter Inc.	Anixter Inc.	1	1	1		3
Jones, Chad	Cisco Systems, Inc.	Cisco Systems, Inc.	1	1	1	1	4
Kim, Yongbum	Broadcom Corporation	Broadcom Corporation	1	1	1	1	4
King, Jonathan	Finisar Corporation	Finisar Corporation	1	1	1	1	4
Kliger, Avi	Broadcom Corporation	Broadcom Corporation	1	1	1		3
Knittle, Curtis	Cable Television Laboratories Inc. (Cable	Cable Television Laboratories Inc. (Cable		1	1	1	3
Kobayashi, Shigeru		Tyco International, Ltd.	1	1	1	1	4
KUO, ALBERT	Realtek Semiconductor Corp.	Realtek Semiconductor Corp.	1	1	1		3
Lackner, Hans	QoSCom GmbH	QoSCom - Quality in Communications - G	1	1	1	1	4
Lane, Brett		Panduit Corp.	1	1	1		3
Larsen, Wayne	CommScope, Inc.	CommScope, Inc.	1	1	1	1	4
Latchman, Ryan	Gennum Corporation	MACOM		1	1		2
Laubach, Mark	Broadcom Corporation	Broadcom Corporation	1	1	1	1	4
Law, David	Hewlett-Packard Ltd	Hewlett-Packard Ltd	1	1	1	1	4
Le Cheminant, Greg	Agilent Technologies, Inc.	Agilent Technologies, Inc.			1	1	2
Lewis, David	JDS Uniphase Corporation	JDS Uniphase Corporation		1	1	1	3
Li, Mike-Peng	Altera Corporation	Altera Corporation	1	1	1	1	4
Li, Wen	Finisar Corporation	Finisar Corporation		1			1
Li, Yizhou	Huawei Technologies Co. Ltd	Huawei Technologies Co. Ltd		1			1
Lichtenegger, Thomas		Avago Technologies	1	1	1	1	4
Liew, Kin Soon		Avago Technologies	1	1	1	1	4
Lin, Ru	Shanghai Luster Teraband Photonics Co.,	Shanghai Luster Teraband Photonics Co.,				1	1
liu, James		Fairchild semiconductor	1	1	1		3
Liu, Zhenyu	Marvell Semiconductor, Inc.	Marvell Semiconductor, Inc.	1	1	1	1	4
Lo, Chi Ho		Linear Technology	1	1	1	1	4
Lo, William	Marvell Semiconductor, Inc.	Marvell Semiconductor, Inc.	1	1	1	1	4
Lukacs, Miklos	Silicon Laboratories	Silicon Laboratories	1	1	1	1	4

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Lusted, Kent	Intel Corporation	Intel Corporation		1	1	1	3
Maguire, Valerie	The Siemon Company	The Siemon Company	1	1	1	1	4
Maki, Jeffery	Juniper Networks, Inc.	Juniper Networks, Inc.	1	1		1	3
Mallette, Edwin	Bright House Networks	Bright House Networks	1	1	1	1	4
mash, chris	Marvell Semiconductor, Inc.	Marvell Semiconductor, Inc.	1	1	1	1	4
Matheus, Kirsten	BMW Group	BMW Group	1	1	1	1	4
Mcdermott, Thomas	FUJITSU	Fujitsu	1	1	1	1	4
McDonough, John	NEC Corporation	NEC America	1	1	1	1	4
McLean, Andrew		Texas Instruments Incorporated			1		1
Mei, Richard	CommScope, Inc.	CommScope, Inc.		1	1	1	3
Mellitz, Richard	Intel Corporation	Intel Corporation	1	1	1	1	4
Meurer, Martin	MD Elektronik GmbH	MD Elektronik GmbH		1	1		2
Mihalache, Razvan	Robert Bosch GmbH	Robert Bosch GmbH	1	1	1	1	4
Mooney, Paul	Spirent Communications	Spirent Communications	1	1	1	1	4
Moore, Charles	Avago Technologies	Avago Technologies	1	1	1	1	4
Mueller, Thomas	Rosenberger Hochfrequenztechnik GmbH	Rosenberger Hochfrequenztechnik GmbH	1	1		1	3
Muyshondt, Henry	MOST Cooperation	MOST Cooperation! SMSC	1	1	1	1	4
Ng, Chun Wing Alan		Bel Fuse		1	1		2
Nielsen, Allan	TE Connectivity	TE Connectivity	1	1	1		3
Nordin, Ronald	Panduit Corp.	Panduit Corp.	1	1	1	1	4
Ofelt, David	Juniper Networks, Inc.	Juniper Networks, Inc.	1	1	1	1	4
Ogura, Ichiro	PETRA	PETRA	1	1	1	1	4
Palkert, Thomas	EIC	Luxtera-Molex	1	1	1	1	4
Pandey, Sujan	NXP Semiconductors	NXP Semiconductors	1	1	1	1	4
Panguluri, Sesa	Broadcom Corporation	Broadcom Corporation	1	1	1		3
Pardo, Carlos	Knowledge Development for POF SL	KDPOF	1	1	1	1	4
Patel, Pravin		IBM	1	1	1		3
Pepper, Gerald	Ixia	Ixia	1	1	1	1	4
Perez De Aranda Alonso, Ruben		KDPOF		1	1	1	3
Picard, Jean		Texas Instruments	1				1

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Poehmerer, Rainer		LEONI	1	1	1	1	4
Powell, William	ALCATEL-LUCENT	ALCATEL-LUCENT	1	1	1	1	4
Prodan, Richard	Broadcom Corporation	Broadcom Corporation	1	1	1	1	4
Rabinovich, Rick	ALCATEL-LUCENT	ALCATEL-LUCENT	1	1	1	1	4
RAN, ADEE	Intel Corporation	Intel Corporation		1	1	1	3
Rao, Ram	Oclaro	Oclaro	1				1
Remein, Duane	Futurewei Technologies	Huawei Technologies Co. Ltd	1	1	1		3
Renteria, Victor	Bel Fuse	Bel Fuse		1	1	1	3
Rimboim, Poldi	Microsemi Corporation	Microsemi Corporation		1	1	1	3
Rotolo, Salvatore	STMicroelectronics	STMicroelectronics	1	1	1	1	4
sambasivan, sam	AT&T	AT&T	1	1	1		3
Sasaki, Yasuo	TE Connectivity Ltd. / Tyco Electronics Ja	Panduit Corp.	1	1	1		3
Schindler, Fred	Seen Simply	Seen Simply	1	1	1	1	4
Schneelee, Stefan	Airbus Group	Airbus Group	1	1	1	1	4
Shellhammer, Stephen	Qualcomm Incorporated	Qualcomm Incorporated		1			1
Shen, Bazhong	Broadcom Corporation	Broadcom Corporation		1	1	1	3
Sommers, Scott	Molex Incorporated	Molex Incorporated	1	1	1	1	4
Song, Xiaolu		Huawei Technologies Co. Ltd	1	1	1	1	4
Stassar, Peter	Huawei Technologies Co. Ltd	Huawei Technologies Co. Ltd	1	1	1	1	4
Stencel, Leonard	Bourns, Inc.	Bourns, Inc		1	1	1	3
Stevens, Daniel	Fujitsu Semiconductor Europe	Fujitsu Semiconductor Europe	1	1	1		3
Stewart, Heath		Linear Technology			1	1	2
Swanson, Steven	Corning Incorporated	Corning Incorporated	1	1	1		3
Szczepanek, Andre	Inphi Corporation	Inphi Corporation	1	1	1	1	4
TAJIMA, AKIO	NEC Corporation	NEC Corporation	1	1	1	1	4
Takahashi, Satoshi	Self Employed	Self Employed	1			1	2
Tan, Alexander	Marvell Semiconductor, Inc.	Marvell Semiconductor, Inc.	1	1		1	3
Tanaka, Toshiki	FUJITSU LABORATORIES LIMITED	FUJITSU LABORATORIES LIMITED	1	1	1	1	4
TAZEBAY, MEHMET	Broadcom Corporation	Broadcom Corporation	1	1		1	3
Thaler, Patricia	Broadcom Corporation	Broadcom Corporation			1		1

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Thompson, Geoffrey	GraCaSI S.A.	GraCaSI S.A.	1	1	1	1	4
To, Leonard		Pulse Electronics		1	1		2
Tracy, Nathan	TE Connectivity	TE Connectivity	1	1	1	1	4
Tremblay, David	Hewlett-Packard Ltd	Hewlett-Packard Company		1	1	1	3
Trowbridge, Stephen	ALCATEL-LUCENT	ALCATEL-LUCENT	1	1	1	1	4
TSENG, WEN-CHENG	MediaTek Inc.	MediaTek Inc.	1	1	1	1	4
Ulrichs, Ed	Source Photonics	Source Photonics		1	1	1	3
Unmehopa, Musa	Philips Electronics	Philips Electronics	1	1	1	1	4
Upadhyaya, Pawan		Cadence Design Systems, Inc.	1	1	1	1	4
Wagner, Robert	Panduit Corp.	Panduit Corp.	1	1	1		3
Wang, Allen		Lenovo	1	1	1	1	4
Wang, Tongtong		Huawei Technologies Co. Ltd	1	1	1		3
Wang, Xiaofeng	PMC-Sierra, Inc.	Qualcomm Incorporated	1	1	1	1	4
Wang, Xinyuan	Huawei Technologies Co. Ltd	Huawei Technologies Co. Ltd	1	1	1		3
Wendt, Matthias	Philips Electronics	Philips Electronics	1	1	1	1	4
Winkel, Ludwig	Siemens AG	Siemens AG	1	1	1	1	4
wu, guangsheng	Huawei Technologies Co. Ltd	Huawei Technologies Co. Ltd		1	1		2
Wu, Peter	Marvell Semiconductor, Inc.	Marvell Semiconductor, Inc.	1	1	1	1	4
Xiao, Sam		Molex Incorporated	1	1	1		3
Xu, Dayin	Rockwell Automation	Rockwell Automation	1	1	1	1	4
Xu, Yu	Huawei Technologies Co. Ltd	Huawei Technologies Co. Ltd	1	1	1		3
yang, siyuan		Cisco Systems, Inc.		1	1		2
Yang, Tao		Freescale Semiconductor, Inc.	1	1	1		3
Yoshimura, Tomonari		Mitsubishi Rayon Co., Ltd.	1			1	2
Yseboodt, Lennart	Philips Electronics	Philips Electronics	1	1	1	1	4
YU, Sam		Microsemi		1	1	1	3
Yuan, Liquan	ZTE Corporation	ZTE Corporation	1	1	1	1	4
Yuki, Hayato		AutoNetworks Technologies, Ltd		1	1	1	3
Zebhauser, Martin	Rosenberger HF-Technik GmbH & Co KG	Rosenberger	1				1
Zeng, Gibson		Lenovo	1	1	1	1	4

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Zhang, Jin	Marvell Semiconductor, Inc.	Marvell Semiconductor, Inc.	1	1	1	1	4
Zhao, Wenyu	Research Institute of Telecommunication	China Academy of Telecommunication R	1	1	1	1	4
Zimmerman, George	CME Consulting	Aquantia and CommScope, Inc.	1	1	1		3
Zinner, Helge		Continental AG	1	1	1	1	4
Zivny, Pavel	Tektronix, Inc.	Tektronix	1	1	1	1	4
Zou, Gaoling	Maxim Integrated Products	Maxim Integrated Products	1	1	1		3